

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5174868

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the THE SIXTH INVENTOR'S NAME previously recorded on Reel 046728 Frame 0807. Assignor(s) hereby confirms the THE CORRECTED INVENTOR'S NAME IS LEESEUL JEONG.
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KWANG-SEONG CHOI	07/12/2018
YONG-SUNG EOM	07/12/2018
KEON-SOO JANG	07/12/2018
SEOK HWAN MOON	07/12/2018
HYUN-CHEOL BAE	07/12/2018
LEESEUL JEONG	07/12/2018
WAGNO ALVES BRAGANCA JUNIOR	07/12/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE
<b>Street Address:</b>	218 GAJEONG-RO, YUSEONG-GU
<b>City:</b>	DAEJEON
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	34129
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16115060
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)408-0924
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	202-371-8976
<b>Email:</b>	firm@rabinberdo.com
<b>Correspondent Name:</b>	RABIN & BERDO, P.C.
<b>Address Line 1:</b>	1101 14TH ST. N.W.
<b>Address Line 2:</b>	SUITE 500
<b>Address Line 4:</b>	WASHINGTON, D.C. 20005
<b>ATTORNEY DOCKET NUMBER:</b>	KOR-678
<b>NAME OF SUBMITTER:</b>	JUN-HWA JEONG

PATENT

<b>SIGNATURE:</b>	/Jun-Hwa Jeong/
<b>DATE SIGNED:</b>	10/05/2018
	This document serves as an Oath/Declaration (37 CFR 1.63).
<b>Total Attachments: 6</b> source=KOR-678_DEC-ASG_as-filed_09-28-18#page1.tif source=KOR-678_DEC-ASG_as-filed_09-28-18#page2.tif source=KOR-678_DEC-ASG_as-filed_09-28-18#page3.tif source=KOR-678_NOR_and_CoverSheet_marked_10-05-18#page1.tif source=KOR-678_NOR_and_CoverSheet_marked_10-05-18#page2.tif source=KOR-678_NOR_and_CoverSheet_marked_10-05-18#page3.tif	

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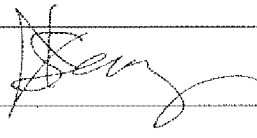
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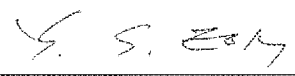
<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KWANG-SEONG CHOI	07/12/2018
YONG-SUNG EOM	07/12/2018
KEON-SOO JANG	07/12/2018
SEOK HWAN MOON	07/12/2018
HYUN-CHEOL BAE	07/12/2018
<del>LEESEUL JUNG</del> LEESEUL JEONG	07/12/2018
WAGNO ALVES BRAGANCA JUNIOR	07/12/2018
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ELECTRONICS AND TELECOMMUNICATIONS RESEARCH INSTITUTE
<b>Street Address:</b>	218 GAJEONG-RO, YUSEONG-GU
<b>City:</b>	DAEJEON
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	34129
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Application Number:	16115060
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<b>Fax Number:</b>	(202)408-0924
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<b>Phone:</b>	202-371-8976
<b>Email:</b>	firm@rabinberdo.com
<b>Correspondent Name:</b>	RABIN & BERDO, P.C.
<b>Address Line 1:</b>	1101 14TH ST., N.W., SUITE 500
<b>Address Line 4:</b>	WASHINGTON, D.C. 20005
<b>ATTORNEY DOCKET NUMBER:</b>	KOR-678
<b>NAME OF SUBMITTER:</b>	ROBERT H. BERDO, JR.
<b>SIGNATURE:</b>	/Robert H. Berdo, Jr./
<b>DATE SIGNED:</b>	08/28/2018

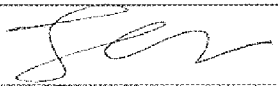
출원 자료를 이용한 실용 또는 디자인 특허 출원 선언 및 양도서 (37 CFR 1.76)  
**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
 USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

<b>발명의 명칭</b> <b>Title of</b> <b>Invention</b>	METHOD OF FABRICATING A SEMICONDUCTOR PACKAGE
<b>선언</b> <b>Declaration</b>	<p>아래에 기명된 발명자로서, 본인은 아래와 같이 선언합니다:          As the below named inventor(s), I hereby declare that:</p> <p>동 선언서 제출처:          The declaration is directed to:</p> <p><input checked="" type="checkbox"/> 첨부된 출원, 또는          The attached application, or</p> <p><input type="checkbox"/> 미국 출원 또는 PCT 국제 출원 번호 _____ 및          출원 일자 _____</p> <p>United States application or PCT international application number  <u>PCT/KR#####</u> filed on _____</p> <p>상기 기재된 출원은 본인이 작성하였거나, 본인의 허락하에 본인 작성으로          신고되었습니다.          The above-identified application was made or authorized to be made by me.</p> <p>본인은 본인이 단독 또는 공동 발명자와 함께 출원서에 주장된 발명사항을 발명한          사람이라고 믿습니다.          I believe that I am the original or an original joint inventor of a claimed invention in the          application.</p> <p>본인은 의도적인 허위 진술이 동 선언서에 기재되었을 경우 18 U.S.C. 1001 에 의거,          벌금형 또는 (5) 년 이하의 징역형 또는 두 가지 형벌을 모두 받을 수 있음을 인지합니다.          I hereby acknowledge that any willful false statement made in this declaration is          punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years          or both.</p>
<b>양도</b> <b>Assignment</b>	<p>NOW, THEREFORE, in consideration of the sum of one dollar (\$1), the receipt whereof          is acknowledge, and other good and valuable consideration, I, by these presents do sell,          assign and transfer unto said assignee(s)</p> <p style="text-align: center;">Electronics and Telecommunications Research Institute          218 Gajeong-ro, Yuseong-gu, Daejeon, 34129, KOREA          Republic of Korea</p> <p>and the heirs, successors, assigns and legal representatives of the assignee(s) the full          and exclusive right to the said invention in the United States and in its territorial          possessions and in any and all foreign countries any and all improvements thereof, the          entire rights, title and interest in and to any and all Patents which may be granted          therefore in the United States. I hereby authorize and request the Director of the U.S.          Patent and Trademark Office to issue said United States Patent to said assignee(s), of the          entire right, title, and interest in and to the same, for his sole use and for the use of his          legal representatives, to the full end of the term for which said Patent may be granted, as          fully and entirely as the same would have been held by me had this assignment and sale          not been made.</p> <p>I agree promptly upon request of the assignee(s), its heirs, successors, assigns and          legal representatives of the assignee(s) to communicate any facts known to it respecting          the patent and the invention set forth therein, and to execute and deliver without further</p>

출원 자료서를 이용한 실용 또는 디자인 특허 출원 선언 및 양도서 (37 CFR 1.76)  
**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION**  
**USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**


	compensation any power of attorney, Assignment, application, whether original, continuation, divisional or reissue, or other papers that may be necessary. I hereby covenant that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale. I further covenant that assignee(s) will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to me and will testify as to the same in any litigation related thereto and will promptly execute and deliver to assignee(s) or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.	
발명자의 법적 성명 Legal Name Of Inventor	발명자 성명(이름, 성): Inventor Name (First Middle LAST):	Kwang-Seong Choi
	발명자 서명: Inventor Signature:	
	일자: Date:	2018. 7. 12.

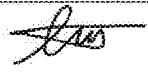
공동 발명자의 법적 성명 Legal Name Of Joint Inventor, If Any	발명자 성명(이름, 성): Inventor Name (First Middle LAST):	Yong-Sung Eom
	발명자 서명: Inventor Signature:	
	일자: Date:	2018. 7. 12

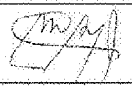
공동 발명자의 법적 성명 Legal Name Of Joint Inventor, If Any	발명자 성명(이름, 성): Inventor Name (First Middle LAST):	Keon-Soo Jang
	발명자 서명: Inventor Signature:	
	일자: Date:	2018. 7. 12.

공동 발명자의 법적 성명 Legal Name Of Joint Inventor, If Any	발명자 성명(이름, 성): Inventor Name (First Middle LAST):	Seok Hwan Moon
	발명자 서명: Inventor Signature:	
	일자: Date:	17.12, 2018

출원 자료를 이용한 실용 또는 디자인 특허 출원 선언 및 양도서 (37 CFR 1.76)  
 DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION  
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공동 발명자의 법적 성명 Legal Name Of Joint Inventor, If Any	발명자 성명(이름, 성): Inventor Name (First Middle LAST):	Hyun-Cheol Bae
	발명자 서명: Inventor Signature:	
	일자: Date:	2018. 07. 12

공동 발명자의 법적 성명 Legal Name Of Joint Inventor, If Any	발명자 성명(이름, 성): Inventor Name (First Middle LAST):	leeseul Jeong
	발명자 서명: Inventor Signature:	
	일자: Date:	2018. 7. 12

공동 발명자의 법적 성명 Legal Name Of Joint Inventor, If Any	발명자 성명(이름, 성): Inventor Name (First Middle LAST):	Wagno Alves Braganca Junior
	발명자 서명: Inventor Signature:	
	일자: Date:	2018. 07. 12